



DISCRIPTION

FEATURES

Ceramic Core
High Frequency Desgin
Lower DCR permits High Idc
Available in E 12 serie
Excellent Q SRF Values
Excellent Thermal Stability
Lead Free versions

OPTIONS

Tape & Reel is Standard (Qty: 2000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: K = 10% and M=20% is Standard,
tighter Tolerance available (MOQ on request)

APPLICATIONS

Modems PDP, LCD TVs convertor
Mobile Radios DC/DC convertor
Cordless Telephones Car radios
Global Positioning Systems
Wireless Communications Equipment
Network Systems
Computer Peripheral Equipment

PHYSICAL CHARACTERISTICS

- Testing : (Equivalents acceptable) Inductance : HP4291A, HP16193A, HPA4286A or equivalent
RDC : QuadTech 1880 mΩ Q : HP4342A SRF : HP4191A
- Rated Current L value drop 10% typ at IDC against its initial value
- Temperature rise 40°C Max Reference ambient temperature
- Solderability : 75% of the terminal electrode shall be convered
- Soldering Methods : Wave, Reflow
- Operating Temperature : -25°C ~ +85°C
- Storage Temperature : -55°C ~ +125°C

ELECTRICAL SPECIFICATIONS

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	33	μH	see Site 2
Q factor		Q	20		min.
DC-resistance		DCR typ.	---	Ω	typ.
DC-resistance		DCR max.	12	Ω	max.
Self-Res. Freq.		SRF	1,0	Mhz	min.
Test-Freq.			1 / 1	KHz / Mhz	
Rated Current		IDC	310	mA	max.
Saturation Current		Isat	---	mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon –Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability functions.

HIGH CURRENT SMT CERAMIC WIRE-WOUND CHIP INDUCTORS

Part No.: **S15008-330**

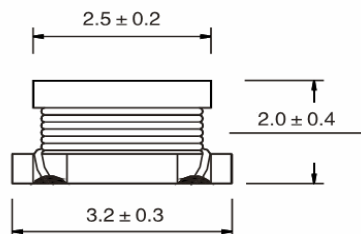
Customer:

DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE	10.06.2009
APPD:	Pong			FINISH	Vienna	Sheet	1 from 2

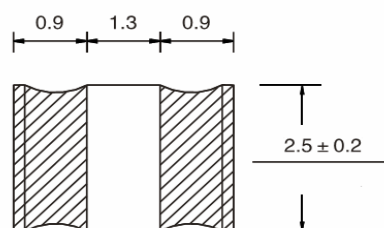


TECHNICAL INFORMATION

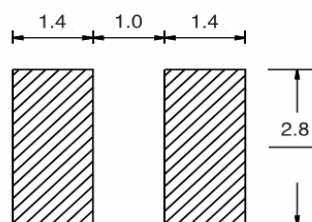
Dimensions (mm)



Typical part marking



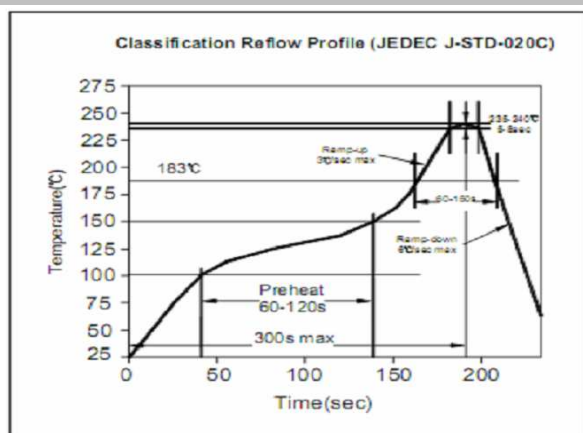
Recommended Layout



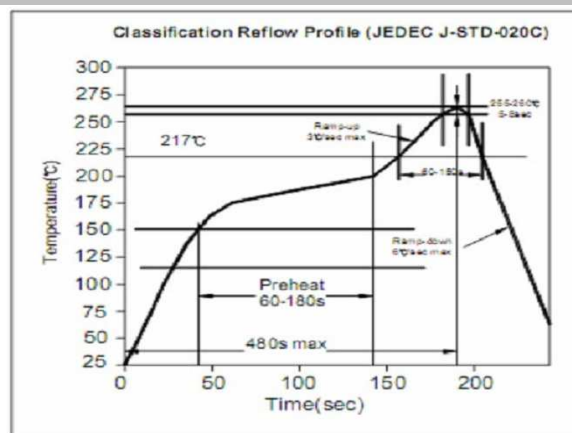
Ordering Information

Serie and Range	Tolerance	ROHS	Packing
S15008-330	K	R	TR
	K = 10%	R = ROHS	BU = Bulk Ware
	M = 20%	N = non ROHS	TR = Tape Reel

Soldering Profile for Lead Free Soldering 235-240°C



Soldering Profile for Lead Free Soldering 255-260°C



1. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon –Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability functions.

HIGH CURRENT SMT CERAMIC WIRE-WOUND CHIP INDUCTORS

Part No.: **S15008-330**

Customer:

DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE	10.06.2009
APPD:	Pong			FINISH	Vienna	Sheet	2 from 2